

74LVT322373 • 74LVTH322373

Low Voltage 32-Bit Transparent Latch with 3-STATE Outputs and 25Ω Series Resistors in the Outputs

General Description

The LVT322373 and LVTH322373 contain thirty-two non-inverting latches with 3-STATE outputs and are intended for bus oriented applications. The device is byte controlled. The flip-flops appear transparent to the data when the Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup time is latched. Data appears on the bus when the Output Enable (\overline{OE}) is LOW. When \overline{OE} is HIGH, the outputs are in a high impedance state.

The LVTH322373 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These latches are designed for low voltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT322373 and LVTH322373 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining a low power dissipation.

Features

- Input and output interface capability to systems at 5V V_{CC}
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH322373), also available without bushold feature (74LVT322373)
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs include equivalent series resistance of 25Ω to make external termination resistors unnecessary and reduce overshoot and undershoot
- ESD performance:
 - Human-body model > 2000V
 - Machine model > 200V
 - Charged-device model > 1000V
- Packaged in plastic Fine-Pitch Ball Grid Array (FBGA)

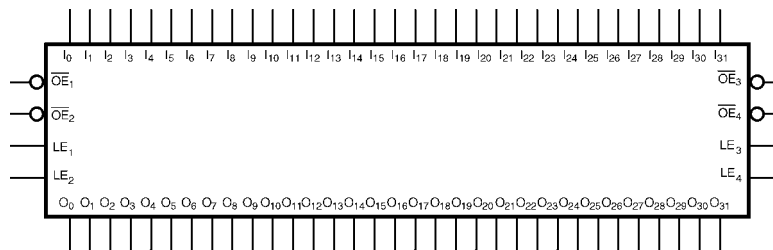
Ordering Code:

Order Number	Package Number	Package Description
74LVT322373G (Note 1) (Note 2)	BGA96A (Preliminary)	96-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
74LVTH322373G (Note 1) (Note 2)	BGA96A	96-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide

Note 1: Ordering Code "G" indicates Trays.

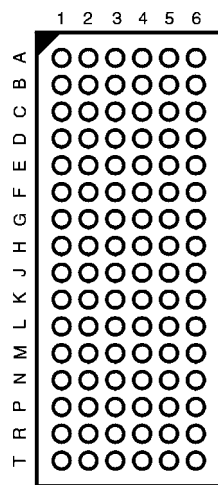
Note 2: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



74LVT322373 • 74LVTH322373 Low Voltage 32-Bit Transparent Latch with 3-STATE Outputs and 25Ω Series Resistors in the Outputs

Connection Diagram



(Top Thru View)

Pin Descriptions

Pin Names	Description
\overline{OE}_n	Output Enable Input (Active LOW)
LE_n	Latch Enable Input
I_0-I_{31}	Inputs
O_0-O_{31}	3-STATE Outputs

FBGA Pin Assignments

	1	2	3	4	5	6
A	O_1	O_0	\overline{OE}_1	LE_1	I_0	I_1
B	O_3	O_2	GND	GND	I_2	I_3
C	O_5	O_4	V_{CC1}	V_{CC1}	I_4	I_5
D	O_7	O_6	GND	GND	I_6	I_7
E	O_9	O_8	GND	GND	I_8	I_9
F	O_{11}	O_{10}	V_{CC1}	V_{CC1}	I_{10}	I_{11}
G	O_{13}	O_{12}	GND	GND	I_{12}	I_{13}
H	O_{14}	O_{15}	\overline{OE}_2	LE_2	I_{15}	I_{14}
J	O_{17}	O_{16}	\overline{OE}_3	LE_3	I_{16}	I_{17}
K	O_{19}	O_{18}	GND	GND	I_{18}	I_{19}
L	O_{21}	O_{20}	V_{CC2}	V_{CC2}	I_{20}	I_{21}
M	O_{23}	O_{22}	GND	GND	I_{22}	I_{23}
N	O_{25}	O_{24}	GND	GND	I_{24}	I_{25}
P	O_{27}	O_{26}	V_{CC2}	V_{CC2}	I_{26}	I_{27}
R	O_{29}	O_{28}	GND	GND	I_{28}	I_{29}
T	O_{30}	O_{31}	\overline{OE}_4	LE_4	I_{31}	I_{30}

Truth Table

Inputs			Outputs
LE_1	\overline{OE}_1	I_0-I_7	O_0-O_7
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O_0

Inputs			Outputs
LE_3	\overline{OE}_3	$I_{16}-I_{23}$	$O_{16}-O_{23}$
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O_0

Inputs			Outputs
LE_2	\overline{OE}_2	I_8-I_{15}	O_8-O_{15}
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O_0

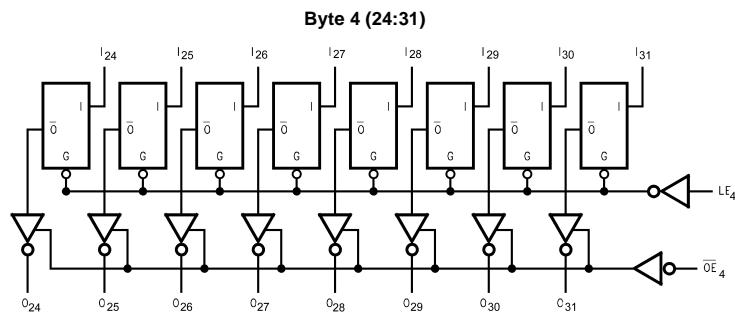
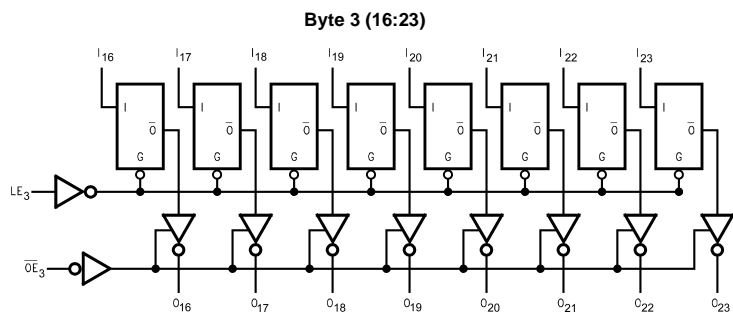
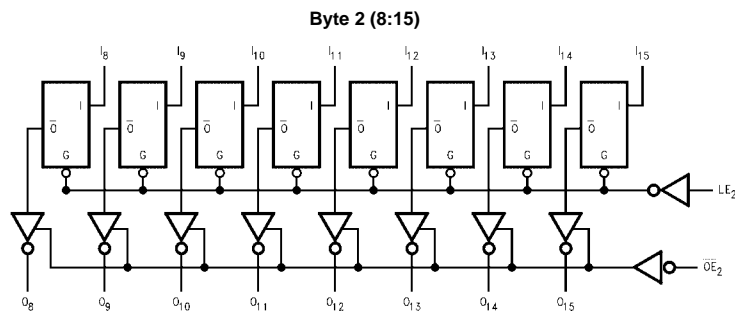
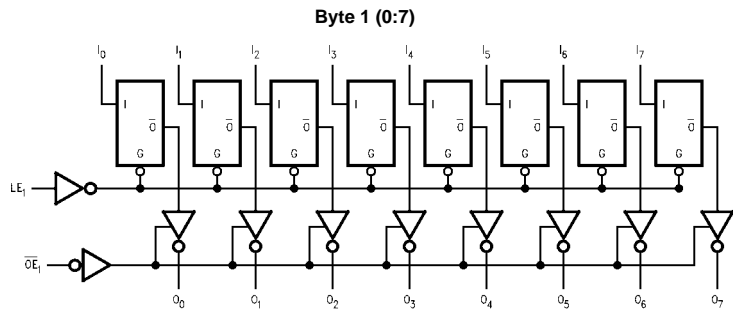
Inputs			Outputs
LE_4	\overline{OE}_4	$I_{24}-I_{31}$	$O_{24}-O_{31}$
X	H	X	Z
H	L	L	L
H	L	H	H
L	L	X	O_0

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial Z = HIGH Impedance O_0 = Previous O_0 prior to HIGH-to-LOW transition of LE

Functional Description

The LVT322373 and LVTH322373 contain thirty-two D-type latches with 3-STATE standard outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 32-bit operation. The following description applies to each byte. When the Latch Enable (LE_n) input is HIGH, data on the D_n enters the latches. In this condition the latches are transparent, i.e., a latch output will change states each time its D input changes. When LE_n is LOW, the latches store information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE_n . The 3-STATE standard outputs are controlled by the Output Enable (\overline{OE}_n) input. When \overline{OE}_n is LOW, the standard outputs are in the 2-state mode. When \overline{OE}_n is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Logic Diagrams



V_{CC1} is associated with Bytes 1 and 2.

V_{CC2} is associated with Bytes 3 and 4.

Note: Please note that these diagrams are provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 3)					
Symbol	Parameter	Value	Conditions		Units
V _{CC}	Supply Voltage	-0.5 to +4.6			V
V _I	DC Input Voltage	-0.5 to +7.0			V
V _O	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE		V
		-0.5 to +7.0	Output in HIGH or LOW State (Note 4)		
I _{IK}	DC Input Diode Current	-50	V _I < GND		mA
I _{OK}	DC Output Diode Current	-50	V _O < GND		mA
I _O	DC Output Current	64	V _O > V _{CC} Output at HIGH State		mA
		128	V _O > V _{CC} Output at LOW State		
I _{CC}	DC Supply Current per Supply Pin	±64			mA
I _{GND}	DC Ground Current per Ground Pin	±128			mA
T _{STG}	Storage Temperature	-65 to +150			°C

Recommended Operating Conditions					
Symbol	Parameter	Min	Max	Units	
V _{CC}	Supply Voltage	2.7	3.6	V	
V _I	Input Voltage	0	5.5	V	
I _{OH}	HIGH Level Output Current		-12	mA	
I _{OL}	LOW Level Output Current		12	mA	
T _A	Free-Air Operating Temperature	-40	85	°C	
Δt/ΔV	Input Edge Rate, V _{IN} = 0.8V to 2.0V, V _{CC} = 3.0V	0	10	ns/V	

Note 3: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

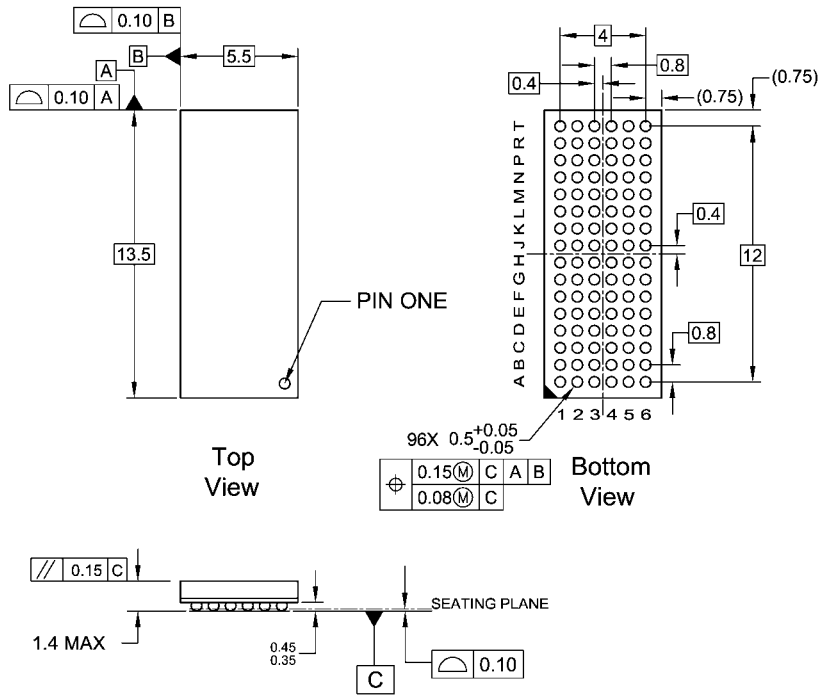
Note 4: I_O Absolute Maximum Rating must be observed.

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	T _A = -40°C to +85°C		Units	Conditions	
			Min	Max			
V _{IK}	Input Clamp Diode Voltage	2.7		-1.2	V	I _I = -18 mA	
V _{IH}	Input HIGH Voltage	2.7 - 3.6	2.0		V	V _O ≤ 0.1V or	
V _{IL}	Input LOW Voltage	2.7 - 3.6		0.8	V	V _O ≥ V _{CC} - 0.1V	
V _{OH}	Output HIGH Voltage	2.7 - 3.6	V _{CC} - 0.2		V	I _{OH} = -100 μA	
		3.0	2.0		V	I _{OH} = -12 mA	
V _{OL}	Output LOW Voltage	2.7		0.2	V	I _{OL} = 100 μA	
		3.0		0.8	V	I _{OL} = 12 mA	
I _{I(HOLD)}	Bushold Input Minimum Drive	3.0	75		μA	V _I = 0.8V	
I _{I(OD)}	Bushold Input Over-Drive Current to Change State	3.0	500		μA	(Note 5)	
			-500			(Note 6)	
I _I	Input Current	3.6		10	μA	V _I = 5.5V	
		Control Pins	3.6			±1	V _I = 0V or V _{CC}
			Data Pins	3.6			-5
				1		V _I = V _{CC}	
I _{OFF}	Power Off Leakage Current	0		±100	μA	0V ≤ V _I or V _O ≤ 5.5V	
I _{PU/PD}	Power up/down 3-STATE Output Current	0 - 1.5V		±100	μA	V _O = 0.5V to 3.0V V _I = GND or V _{CC}	
I _{OZL}	3-STATE Output Leakage Current	3.6		-5	μA	V _O = 0.5V	
I _{OZH}	3-STATE Output Leakage Current	3.6		5	μA	V _O = 3.0V	
I _{OZH+}	3-STATE Output Leakage Current	3.6		10	μA	V _{CC} < V _O ≤ 5.5V	
I _{CCH}	Power Supply Current (V _{CC1} or V _{CC2})	3.6		0.19	mA	Outputs HIGH	
I _{CCL}	Power Supply Current (V _{CC1} or V _{CC2})	3.6		5	mA	Outputs LOW	
I _{CCZ}	Power Supply Current (V _{CC1} or V _{CC2})	3.6		0.19	mA	Outputs Disabled	

DC Electrical Characteristics (Continued)							
Symbol	Parameter	V _{CC} (V)	T _A = -40°C to +85°C		Units	Conditions	
			Min	Max			
I _{CCZ+}	Power Supply Current (V _{CC1} or V _{CC2})	3.6		0.19	mA	V _{CC} ≤ V _O ≤ 5.5V, Outputs Disabled	
ΔI _{CC}	Increase in Power Supply Current (V _{CC1} or V _{CC2}) (Note 7)	3.6		0.2	mA	One Input at V _{CC} - 0.6V Other Inputs at V _{CC} or GND	
<p>Note 5: An external driver must source at least the specified current to switch from LOW-to-HIGH.</p> <p>Note 6: An external driver must sink at least the specified current to switch from HIGH-to-LOW.</p> <p>Note 7: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.</p>							
Dynamic Switching Characteristics (Note 8)							
Symbol	Parameter	V _{CC} (V)	T _A = 25°C			Units	Conditions C _L = 50 pF, R _L = 500Ω
			Min	Typ	Max		
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3		0.8	V	(Note 9)	
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3		-0.8	V	(Note 9)	
<p>Note 8: Characterized in SSOP package. Guaranteed parameter, but not tested.</p> <p>Note 9: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.</p>							
AC Electrical Characteristics							
Symbol	Parameter	T _A = -40°C to +85°C, C _L = 50pF, R _L = 500Ω				Units	
		V _{CC} = 3.3V ± 0.3V		V _{CC} = 2.7V			
		Min	Max	Min	Max		
t _{PHL}	Propagation Delay D _n to O _n	1.3	4.8	1.3	5.3	ns	
t _{PLH}	Propagation Delay LE to O _n	1.4	4.8	1.4	5.1		
t _{PHL}	Propagation Delay D _n to O _n	1.7	5.0	1.7	5.1	ns	
t _{PLH}	Propagation Delay LE to O _n	1.4	5.1	1.4	5.8		
t _{PZL}	Output Enable Time	1.6	5.0	1.6	6.0	ns	
t _{PZH}	Output Disable Time	1.0	5.4	1.0	6.6		
t _{PLZ}	Output Disable Time	1.6	5.1	1.6	5.0	ns	
t _{PHZ}	Output Enable Time	1.8	5.4	1.8	5.7		
t _S	Setup Time, D _n to LE	1.0		0.8		ns	
t _H	Hold Time, D _n to LE	1.0		1.1		ns	
t _W	LE Pulse Width	3.0		3.0		ns	
t _{OSHL}	Output to Output Skew (Note 10)		1.0		1.0	ns	
t _{OSLH}	Output to Output Skew (Note 10)		1.0		1.0		
<p>Note 10: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).</p>							
Capacitance (Note 11)							
Symbol	Parameter	Conditions			Typical	Units	
C _{IN}	Input Capacitance	V _{CC} = Open, V _I = 0V or V _{CC}			4	pF	
C _{OUT}	Output Capacitance	V _{CC} = 3.0V, V _O = 0V or V _{CC}			8	pF	
<p>Note 11: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.</p>							

Physical Dimensions inches (millimeters) unless otherwise noted



NOTES:

- A. THIS PACKAGE CONFORMS TO JEDEC MO-205
- B. ALL DIMENSIONS IN MILLIMETERS
- C. LAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)
.35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
- D. DRAWING CONFORMS TO ASME Y14.5M-1994

BGA96ArevE

**96-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
Package Number BGA96A
Preliminary**

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